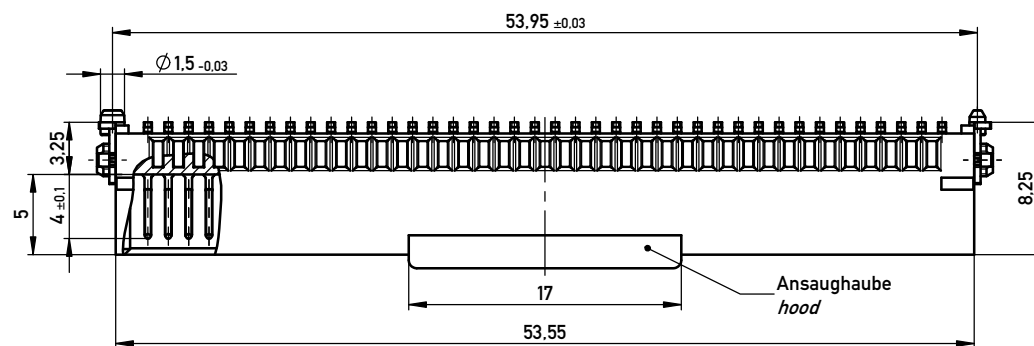
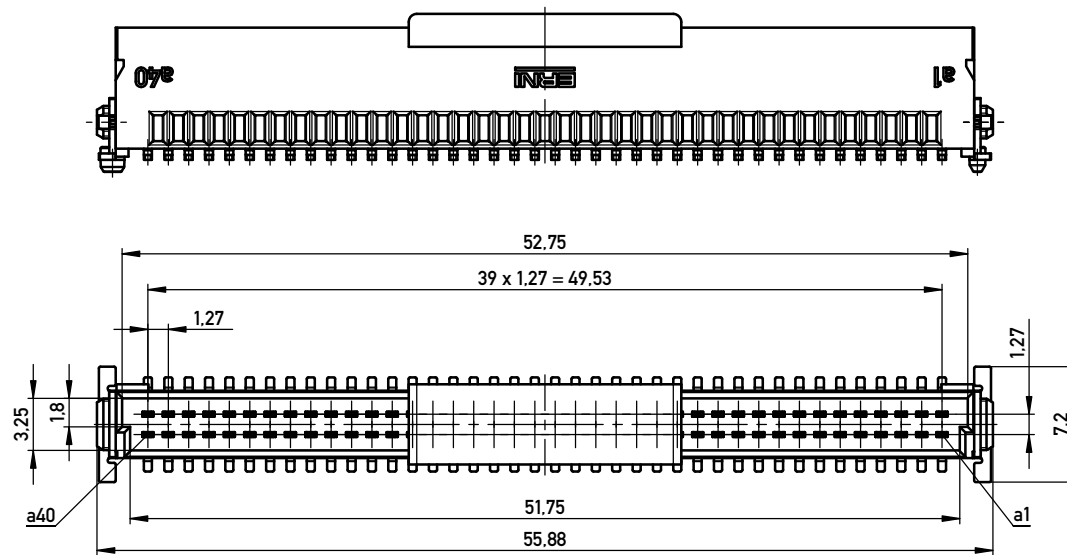
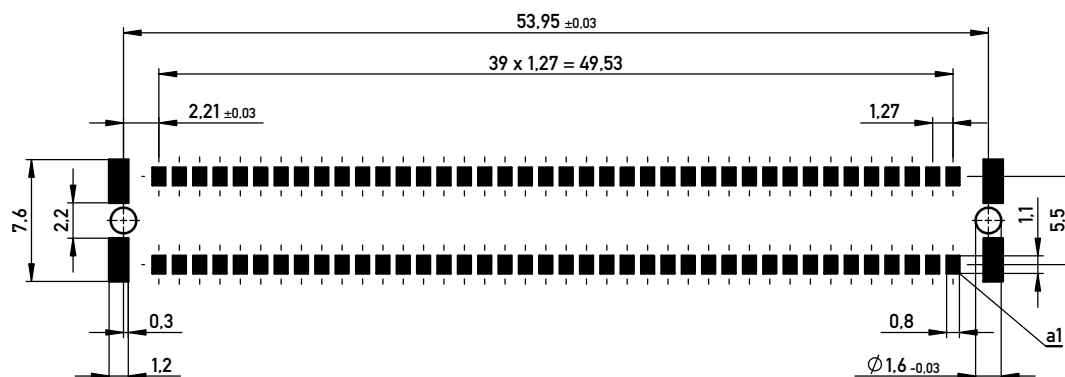




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



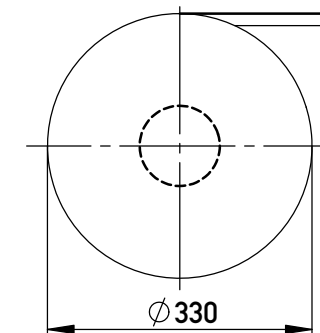
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

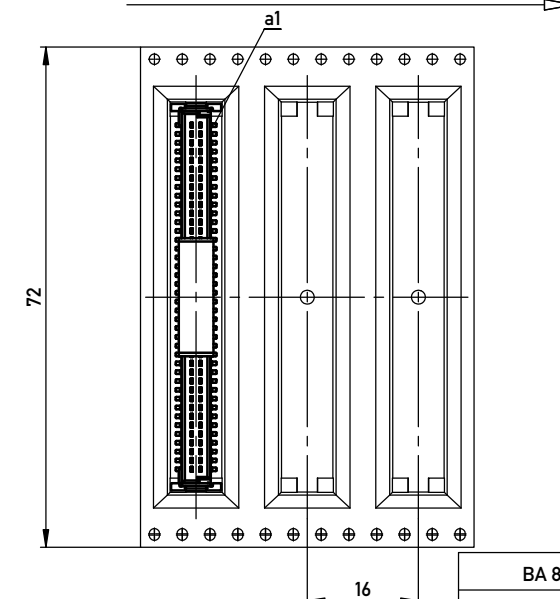
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt in Gurtverpackung
Tape on Reel Packaging
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA 8-03 - Standard Bauhöhe

type 8-03 - Standard Assembly Height

Information:				Tolerances		 All Dimensions in mm		Scale		3:1	
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						www.ERNI.com		244858			
d		08.07.2013									
Index		Date						Class SMCQ			
										I A3	

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